TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74AC540P, TC74AC540F, TC74AC540FT TC74AC541P, TC74AC541F, TC74AC541FT

Octal Bus Buffer

TC74AC540P/F/FT Inverting, 3-State

Outputs

TC74AC541P/F/FT Non-Inverting, 3-State

Outputs

The TC74AC540/TC74AC541 are advanced high speed CMOS OCTAL BUS BUFFERs fabricated with silicon gate and double-layer metal wiring  $\rm C^2MOS$  technology.

They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The TC74AC540 is an inverting type, and the TC74AC541 is a non-inverting type.

When either  $\overline{G}1$  or  $\overline{G}2$  are high, the terminal outputs are in the high-impedance state.

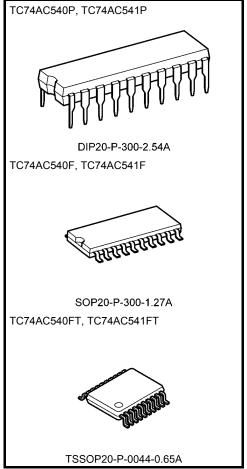
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### **Features**

- High speed:  $t_{pd} = 4.0 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 8 \mu A$  (max) at  $T_a = 25$ °C
- High noise immunity: V<sub>NIH</sub> = V<sub>NIL</sub> = 28% V<sub>CC</sub> (min)
- Symmetrical output impedance:  $|I_{OH}| = I_{OL} = 24$  mA (min) Capability of driving 50  $\Omega$

transmission lines.

- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range:  $V_{CC (opr)} = 2 \text{ to } 5.5 \text{ V}$
- Pin and function compatible with 74F540/541

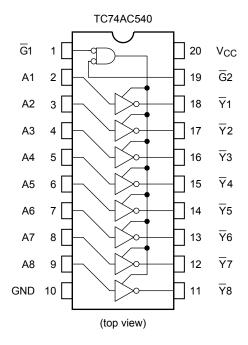


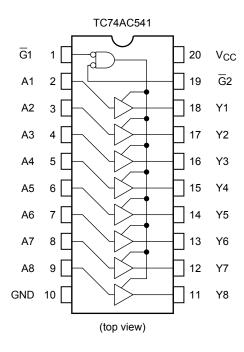
Weight

DIP20-P-300-2.54A : 1.30 g (typ.) SOP20-P-300-1.27A : 0.22 g (typ.) TSSOP20-P-0044-0.65A : 0.08 g (typ.)

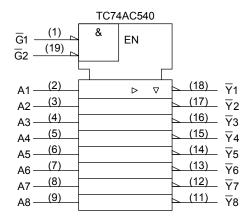
# **TOSHIBA**

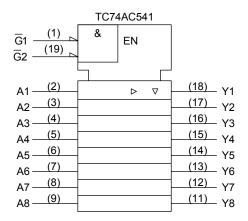
#### **Pin Assignment**





#### **IEC Logic Symbol**





#### **Truth Table**

	Inputs	Outputs			
G1	G2 A <sub>n</sub>		Yn	$\overline{Y}_n$	
Н	Х	Х	Z	Z	
Х	Н	Х	Z	Z	
L	L	Н	Н	L	
L	L	L	L	Н	

X: Don't care

Z: High impedance

 $Y_n$ : AC541  $\overline{Y}_n$ : AC540

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#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	$V_{CC}$	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	l <sub>IK</sub>	±20	mA
Output diode current	lok	±50	mA
DC output current	lout	±50	mA
DC V <sub>CC</sub> /ground current	I <sub>CC</sub>	±200	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP/TSSOP)	mW
Storage temperature	T <sub>stg</sub>	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C should be applied up to 300 mW.

#### **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit	
Supply voltage	V <sub>CC</sub>	2.0 to 5.5	V	
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	<b>V</b>	
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	>	
Operating temperature	T <sub>opr</sub>	−40 to 85	°C	
Input rise and fall time	dt/dV	0 to 100 (V <sub>CC</sub> = 3.3 ± 0.3 V)	ns/V	
input rise and fall time	αναν	0 to 20 (V <sub>CC</sub> = 5 ± 0.5 V)	115/ V	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

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#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition			Ta = 25°C		Ta = −40 to 85°C		Unit		
- Characteristics - Cymbol	Cymbol			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Offic	
		_		2.0	1.50	_	_	1.50	_	V	
High-level input voltage	$V_{IH}$			3.0	2.10	_	_	2.10	_		
					5.5	3.85	_	_	3.85	_	
				2.0	_	_	0.50	_	0.50		
Low-level input voltage	$V_{IL}$		_		3.0	_	_	0.90	_	0.90	V
· ·					5.5	-	_	1.65	_	1.65	
					2.0	1.9	2.0	_	1.9	_	
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA		3.0	2.9	3.0	_	2.9	_	
High-level output	V <sub>OH</sub>				4.5	4.4	4.5	_	4.4	_	V
voltage	VОН		I <sub>OH</sub> = -4 mA		3.0	2.58	_	_	2.48	_	v
			I <sub>OH</sub> = −24 mA		4.5	3.94	_	_	3.80	_	
			I <sub>OH</sub> = −75 mA	(Note)	5.5	-	_	_	3.85	_	
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>			2.0	_	0.0	0.1	_	0.1	- V
			I <sub>OL</sub> = 50 μA		3.0	_	0.0	0.1	_	0.1	
Low-level output	Voi				4.5	_	0.0	0.1	_	0.1	
voltage	V <sub>OL</sub>		I <sub>OL</sub> = 12 mA		3.0	_	_	0.36	_	0.44	
			I <sub>OL</sub> = 24 mA		4.5	_	_	0.36	_	0.44	
			I <sub>OL</sub> = 75 mA	(Note)	5.5	_	_	_	_	1.65	
3-state output off-state current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND		5.5	_	_	±0.5	_	±5.0	μА	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	±0.1	_	±1.0	μΑ	
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	8.0	_	80.0	μΑ	

Note: This spec indicates the capability of driving 50  $\Omega$  transmission lines. One output should be tested at a time for a 10 ms maximum duration.



#### AC Characteristics ( $C_L$ = 50 pF, $R_L$ = 500 $\Omega$ , input: $t_r$ = $t_f$ = 3 ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = −40 to 85°C		Unit
	- <b>,</b>		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
Propagation delay	t <sub>pLH</sub>		$3.3 \pm 0.3$	_	6.8	10.5	1.0	12.0	no
time (Note 2)	$t_{pHL}$	_	5.0 ± 0.5	_	4.7	7.0	1.0	8.0	ns
Propagation delay	t <sub>pLH</sub>		$3.3 \pm 0.3$	_	6.8	11.4	1.0	13.0	ns
time (Note 3)	$t_{pHL}$	_	5.0 ± 0.5	_	4.7	7.5	1.0	8.5	
Output enable time	t <sub>pZL</sub>	_	$3.3 \pm 0.3$	_	9.6	15.8	1.0	18.0	ns
	$t_{pZH}$		5.0 ± 0.5	_	6.4	10.0	1.0	11.4	
Output disable time	t <sub>pLZ</sub>		$3.3 \pm 0.3$	_	7.7	12.3	1.0	14.0	ns
	$t_{pHZ}$	_	5.0 ± 0.5	_	6.4	9.2	1.0	10.5	
Input capacitance	C <sub>IN</sub>	_		_	5	10	_	10	pF
Output capacitance	C <sub>OUT</sub>	_		_	10	_	_	_	pF
Power dissipation	C <sub>PD</sub>	TC74AC540		_	25	_	_	_	nE.
capacitance	(Note 1)	TC74AC541		_	28	_	_	_	pF

Note1: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

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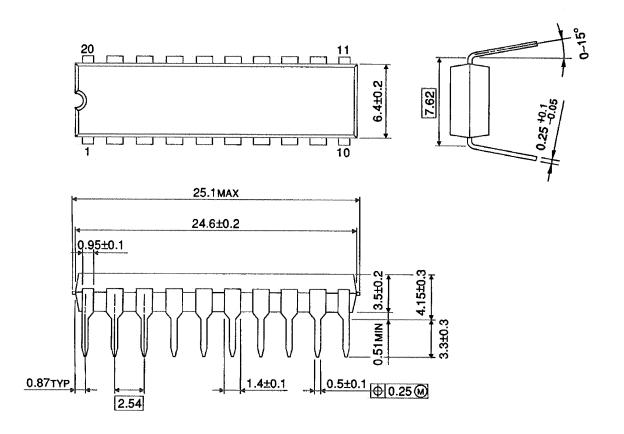
Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 (per bit)$ 

Note 2: For TC74AC540 only Note 3: For TC74AC541 only

# **Package Dimensions**

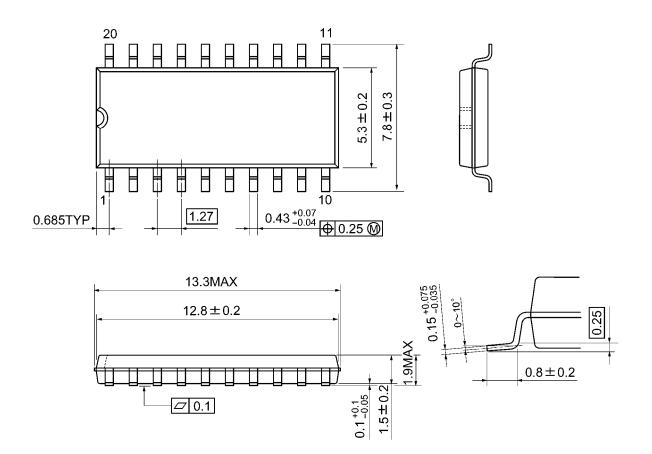
DIP20-P-300-2.54A Unit: mm



Weight: 1.30 g (typ.)

# **Package Dimensions**

SOP20-P-300-1.27A Unit: mm

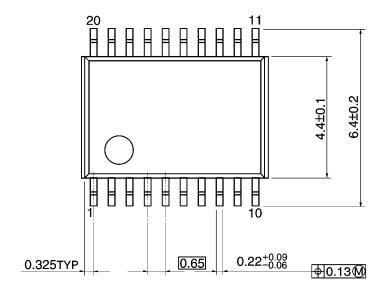


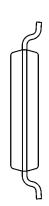
Weight: 0.22 g (typ.)

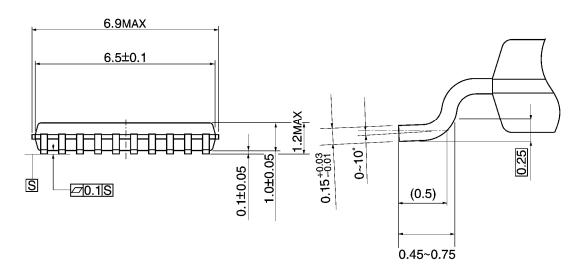
# **Package Dimensions**

TSSOP20-P-0044-0.65A

Unit: mm







Weight: 0.08 g (typ.)

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